

# THERMINIC 2016

|| 22<sup>nd</sup> INTERNATIONAL WORKSHOP  
Thermal Investigations of ICs and Systems ||  
SEPTEMBER 21 - 23, 2016 | BUDAPEST, HUNGARY

## Best Paper Award

*for the outstanding contribution to the technical program of the 22<sup>nd</sup> THERMINIC Workshop  
authored by*

**Dustin Kendig, Andrew Tay, Ali Shakouri**

*titled*

*Thermal Analysis of Advanced Microelectronic Devices Using Thermoreflectance  
Thermography*



**Chris Bailey**  
General Chair



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